



2DB1697

### LOW V<sub>CE(SAT)</sub> PNP SURFACE MOUNT TRANSISTOR

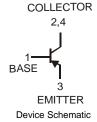
### **Features**

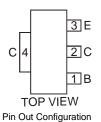
- Epitaxial Planar Die Construction
- Ideally Suited for Automated Assembly Processes
- Ideal for Medium Power Switching or Amplification Applications
- Complementary NPN Type Available (2DD2661)
- Lead Free By Design/RoHS Compliant (Note 1)
- "Green" Device (Note 2)

## **Mechanical Data**

- Case: SOT89-3L
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Finish Matte Tin annealed over Copper leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.072 grams (approximate)







**Maximum Ratings** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	$V_{CBO}$	-15	V
Collector-Emitter Voltage	$V_{CEO}$	-12	V
Emitter-Base Voltage	$V_{EBO}$	-6	V
Peak Pulse Current	Ісм	-4	Α
Continuous Collector Current	lc	-2	Α

#### Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 3) @ T <sub>A</sub> = 25°C	P <sub>D</sub>	0.9	W
Thermal Resistance, Junction to Ambient Air (Note 3) @ T <sub>A</sub> = 25°C	$R_{ hetaJA}$	139	°C/W
Power Dissipation (Note 4) @ T <sub>A</sub> = 25°C	$P_{D}$	2	W
Thermal Resistance, Junction to Ambient Air (Note 4) @ T <sub>A</sub> = 25°C	$R_{ hetaJA}$	62.5	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

# **Electrical Characteristics** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Conditions
OFF CHARACTERISTICS						
Collector-Base Breakdown Voltage	V <sub>(BR)CBO</sub>	-15	_	_	V	$I_C = -10\mu A, I_E = 0$
Collector-Emitter Breakdown Voltage (Note 5)	V <sub>(BR)CEO</sub>	-12	_	_	V	$I_C = -1 \text{mA}, I_B = 0$
Emitter-Base Breakdown Voltage	V <sub>(BR)EBO</sub>	-6	_	_	V	$I_E = -10\mu A, I_C = 0$
Collector Cut-Off Current	I <sub>CBO</sub>	_	_	-0.1	μΑ	$V_{CB} = -15V, I_{E} = 0$
Emitter Cut-Off Current	I <sub>EBO</sub>	_	_	-0.1	μΑ	$V_{EB} = -6V, I_{C} = 0$
ON CHARACTERISTICS (Note 5)						
Collector-Emitter Saturation Voltage	V <sub>CE(SAT)</sub>	_	-65	-180	mV	$I_C = -1A$ , $I_B = -50mA$
DC Current Gain	h <sub>FE</sub>	270		680	_	$V_{CE} = -2V, I_{C} = -200 \text{mA}$
SMALL SIGNAL CHARACTERISTICS						
Output Capacitance	C <sub>obo</sub>		40	_	pF	$V_{CB} = -10V, I_{E} = 0,$ f = 1MHz
Current Gain-Bandwidth Product	f⊤	_	140		MHz	$V_{CE} = -2V, I_{C} = -100mA,$ f = 100MHz

Notes

- 1. No purposefully added lead.
- 2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead\_free/index.php.
- 3. Device mounted on FR-4 PCB with minimum recommended pad layout.
- 4. Device mounted on FR-4 PCB with 1 inch<sup>2</sup> copper pad layout.
- 5. Measured under pulsed conditions. Pulse width =  $300\mu$ s. Duty cycle  $\leq$ 2%.



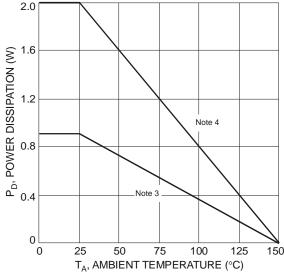
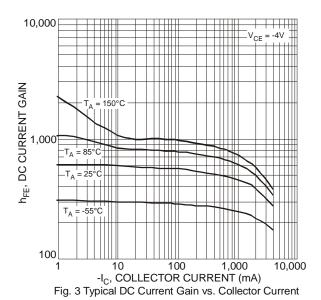


Fig. 1 Power Dissipation vs. Ambient Temperature



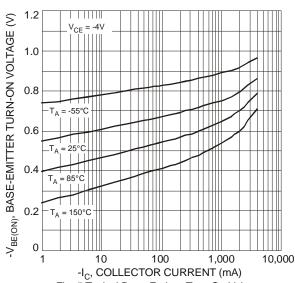
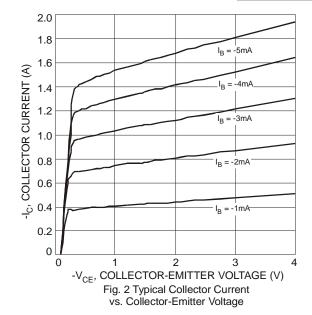


Fig. 5 Typical Base-Emitter Turn-On Voltage vs. Collector Current



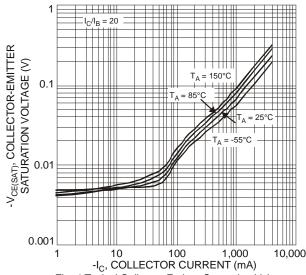


Fig. 4 Typical Collector-Emitter Saturation Voltage vs. Collector Current

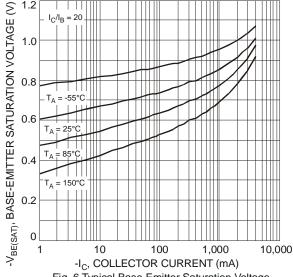
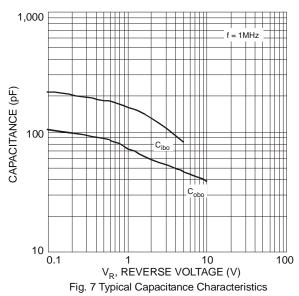
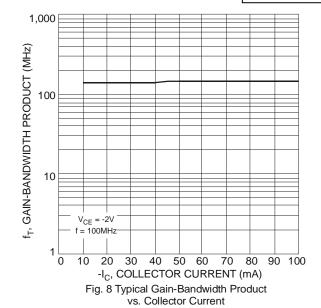


Fig. 6 Typical Base-Emitter Saturation Voltage vs. Collector Current





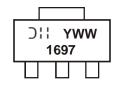


# Ordering Information (Note 6)

Part Number	Case	Packaging
2DB1697-13	SOT89-3L	2500/Tape & Reel

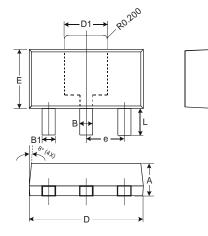
Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

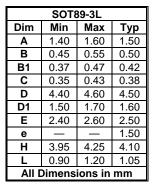
# **Marking Information**



1697 = Product Type Marking Code YWW = Date Code Marking Y = Last digit of year (ex: 8 = 2008) WW = Week code 01 - 52

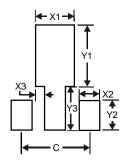
# **Package Outline Dimensions**







# **Suggested Pad Layout**



<b>Dimensions</b>	Value (in mm)
X1	1.7
X2	0.9
Х3	0.4
Y1	2.7
Y2	1.3
Y3	1.9
С	3.0

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